



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Examiner: J. ZIMMERMAN; Art Unit: 1775; Docket No.: 1109

In RE: Application of Martin SCHALLNER, et al

Ser. No.: 09/532,144

Filed: March 21, 2000

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Sir:

In accordance with the duty of disclosure, please accept the accompanying
prior art references along with a description of its relevance:

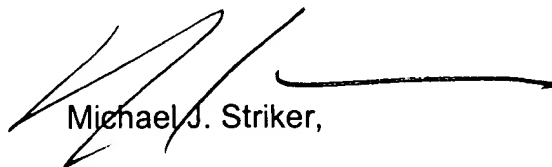
Prior Art References

1. IEEE Standard Dictionary of Electrical and Electronics Terms, Fourth Edition, American National Standard, p. 1009. This page contains a definition of "thin film technology". The definition is "a technology in which a film of a few hundreds to a few thousand angstroms is applied by vacuum deposition to an insulating substrate". This has been filed to support arguments in the accompanying amendment.

2. Routledge German Technical Dictionary, Volume 1, German-English, London and New York, p. 155. This reference is in both German and English. The term "Dünnschicht" is translated as "thin film". Also e.g. "Dünnschichtleiter" is translated "thin film conductor"; etc.

Any additional costs involved should be charged to the deposit account of the undersigned (No.19-4675). Alternatively, should the Examiner feel that a personal discussion might be helpful, he or she is invited to telephone the undersigned at 516-549-4700.

Respectfully submitted,



Michael J. Striker,

Attorney for the Applicants

Reg. No. 27,233

